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250 MHz



LMH6654/LMH6655

Single/Dual Low Power, 250 MHz, Low Noise Amplifiers

General Description

The LMH6654/LMH6655 single and dual high speed, voltage feedback amplifiers are designed to have unity-gain stable operation with a bandwidth of 250 MHz. They operate from ±2.5V to ±6V and each channel consumes only 4.5 mA. The amplifiers feature very low voltage noise and wide output swing to maximize signal-to-noise ratio.

The LMH6654/LMH6655 have a true single supply capability with input common mode voltage range extending 150 mV below negative rail and within 1.3V of the positive rail.

LMH6654/LMH6655 high speed and low power combination make these products an ideal choice for many portable, high speed application where power is at a premium.

The LMH6654 is packaged in 5-Pin SOT-23 and 8-Pin SOIC. The LMH6655 is packaged in 8-Pin MSOP and 8-Pin SOIC.

The LMH6654/LMH6655 are built on National's Advance VIP10™ (Vertically Integrated PNP) complementary bipolar process.

Features

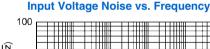
 $(V_S = \pm 5V, T_A = 25^{\circ}C, Typical values unless specified).$

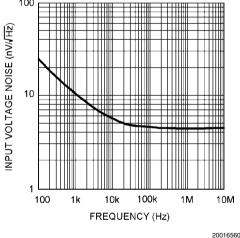
- Voltage feedback architecture
- Unity gain bandwidth
- ±2.5V to ±6V Supply voltage range
- Slew rate 200 V/µsec
- Supply current 4.5 mA/channel
- Input common mode voltage -5.15V to +3.7V
- Output voltage swing $(R_1 = 100\Omega)$ -3.6V to 3.4V
- Input voltage noise 4.5 nV/√Hz
- 1.7 pA/√Hz
- Input current noise Settling Time to 0.01% 25 ns

Applications

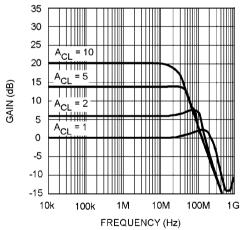
- ADC drivers
- Consumer video
- Active filters
- Pulse delay circuits
- xDSL receiver
- Pre-amps

Typical Performance Characteristics





Closed Loop Gain vs. Frequency



20016558

VIP10™ is a trademark of National Semiconductor Corporation.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

ESD Tolerance (Note 2)
Human Body Model 2 kV
Machine Model 200V V_{IN} Differential $\pm 1.2V$ Output Short Circuit Duration (Note 3)
Supply Voltage (V+ - V-) 13.2V
Voltage at Input pins $V^+ + 0.5V$, $V^- - 0.5V$ Storage Temperature Range -65° C to $+150^{\circ}$ C

Junction Temperature (Note 4) +150°C

Soldering Information

Infrared or Convection (20 sec.) 235°C

Wave Soldering (10 sec.) 260°C

Operating Ratings (Note 1)

Supply Voltage (V+ - V-) ± 2.5 V to ± 6.0 V Junction Temperature Range -40°C to +85°C

Thermal Resistance (θ_{1Δ})

8-Pin SOIC 172°C/W 8-Pin MSOP 235°C/W 5-Pin SOT-23 265°C/W

±5V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J = 25^{\circ}C$, $V^+ = +5V$, $V^- = -5V$, $V_{CM} = 0V$, $A_V = +1$, $R_F = 25\Omega$ for gain = +1, $R_F = 402\Omega$ for gain = \geq +2, and $R_L = 100\Omega$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units	
Dynamic I	Performance	L	(**************************************	(**************************************	(**************************************		
		A _V = +1		250			
		A _V = +2		130		NAL 1-	
f _{CL}	Close Loop Bandwidth	A _V = +5		52		MHz	
		A _V = +10		26			
0.014/0	Gain Bandwidth Product	A _V ≥ +5		260		MHz	
GBWP	Bandwidth for 0.1 dB Flatness	A _V +1		18		MHz	
φm	Phase Margin			50		deg	
SR	Slew Rate (Note 8)	$A_V = +1, V_{IN} = 2 V_{PP}$		200		V/µs	
t _S	Settling Time 0.01%	A _V = +1, 2V Step		25		ns	
	0.1%			15		ns	
t _r	Rise Time	A _V = +1, 0.2V Step		1.4		ns	
t _f	Fall Time	A _V = +1, 0.2V Step		1.2		ns	
Distortion	and Noise Response						
e _n	Input Referred Voltage Noise	f ≥ 0.1 MHz		4.5		nV/√Hz	
i _n	Input-Referred Current Noise	f ≥ 0.1 MHz		1.7		pA/√Hz	
	Second Harmonic Distortion	A _V = +1, f = 5 MHz		-80		-ID-	
	Third Harmonic Distortion	$V_{O} = 2 V_{PP}, R_{L} = 100\Omega$		-85		dBc	
X _t	Crosstalk (for LMH6655 only)	Input Referred, 5 MHz, Channel-to-Channel		-80		dB	
DG	Differential Gain	$A_V = +2$, NTSC, $R_L = 150\Omega$		0.01		%	
DP	Differential Phase	$A_V = +2$, NTSC, $R_L = 150\Omega$		0.025		deg	
Input Cha	racteristics		•				
V _{OS}	Input Offset Voltage	V _{CM} = 0V	-3 -4	±1	3 4	mV	
TC V _{OS}	Input Offset Average Drift	V _{CM} = 0V (Note 7)		6		μV/°C	
I _B	Input Bias Current	$V_{CM} = 0V$		5	12 18	μΑ	
I _{os}	Input Offset Current	V _{CM} = 0V	−1 −2	0.3	1 2	μΑ	
B	Input Posistanco	Common Mode		4		MΩ	
R _{IN}	Input Resistance	Differential Mode		20		kΩ	

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units	
C _{IN}	Input Capacitance	Common Mode		1.8		pF	
		Differential Mode		1			
CMRR	Common Mode Rejection Ration	Input Referred, V _{CM} = 0V to -5V	70 68	90		dB	
CMVR	Input Common- Mode Voltage Range	CMRR ≥ 50 dB		-5.15	-5.0	V	
		J	3.5	3.7			
A _{VOL}	Large Signal Voltage Gain	$V_{O} = 4 V_{PP}, R_{L} = 100\Omega$	60 58	67		dB	
Output Ch	aracteristics						
	Output Swing High	No Load	3.4 3.2	3.6		V	
V _O	Output Swing Low	No Load		-3.9	−3.7 −3.5		
	Output Swing High	R _L = 100Ω	3.2 3.0	3.4			
	Output Swing Low	R _L = 100Ω		-3.6	−3.4 −3.2		
	Short Circuit Current (Note 3)	Sourcing, $V_O = 0V$ $\Delta V_{IN} = 200 \text{ mV}$	145 130	280		A	
I _{SC}		Sinking, $V_O = 0V$ $\Delta V_{IN} = 200 \text{ mV}$	100 80	185		mA	
	Output Current	Sourcing, V _O = +3V		80			
I _{OUT}		Sinking, $V_0 = -3V$		120		mA	
R _o	Output Resistance	$A_V = +1, f < 100 \text{ kHz}$		0.08		Ω	
Power Sup	pply	•	•		!		
PSRR	Power Supply Rejection Ratio	Input Referred, V _S = ±5V to ±6V	60	76		dB	
I _S	Supply Current (per channel)			4.5	6 7	mA	

5V Electrical Characteristics

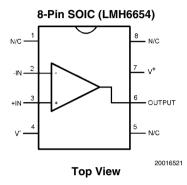
Unless otherwise specified, all limits guaranteed for T_J = 25°C, V^+ = +5V, V^- = -0V, V_{CM} = 2.5V, A_V = +1, R_F = 25 Ω for gain = +1, R_F = 402 Ω for gain = ≥ +2, and R_L = 100 Ω to V+/2. **Boldface** limits apply at the temperature extremes.

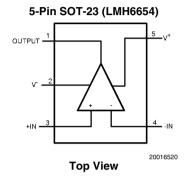
Symbol	Parameter	Conditions	Min	Тур	Max	Units
			(Note 6)	(Note 5)	(Note 6)	
Dynamic I	Performance					
		A _V = +1		230		MHz
£	Olasa I asa Basakaidh	A _V = +2		120		
f _{CL}	Close Loop Bandwidth	A _V = +5		50		
		A _V = +10		25		
GBWP	Gain Bandwidth Product	A _V ≥ +5		250		MHz
	Bandwidth for 0.1 dB Flatness	A _V = +1		17		MHz
φm	Phase Margin			48		deg
SR	Slew Rate (Note 8)	$A_V = +1, V_{IN} = 2 V_{PP}$		190		V/µs
t _S	Settling Time 0.01%	A _V = +1, 2V Step		30		ns
	0.1%			20		ns
t _r	Rise Time	A _V = +1, 0.2V Step		1.5		ns
t _f	Fall Time	A _V = +1, 0.2V Step		1.35		ns

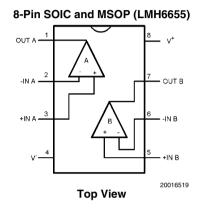
Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
Distortion	and Noise Response					
e _n	Input Referred Voltage Noise	f ≥ 0.1 MHz		4.5		nV/√Hz
i _n	Input Referred Current Noise	f ≥ 0.1 MHz		1.7		pA/√Hz
	Second Harmonic Distortion	A _V = +1, f = 5 MHz		-65		
	Third Harmonic Distortion	$V_0 = 2 V_{PP}, R_L = 100\Omega$		-70		dBc
$\overline{X_t}$	Crosstalk (for LMH6655 only)	Input Referred, 5 MHz		-78		dB
Input Cha	racteristics	•			•	
V _{OS}	Input Offset Voltage	V _{CM} = 2.5V	−5 −6.5	±2	5 6.5	mV
TC V _{OS}	Input Offset Average Drift	V _{CM} = 2.5V (Note 7)		6		μV/°C
I _B	Input Bias Current	V _{CM} = 2.5V		6	12 18	μΑ
I _{os}	Input Offset Current	V _{CM} = 2.5V	-2 -3	0.5	2 3	μΑ
	Input Posistanos	Common Mode		4		ΜΩ
R _{IN}	Input Resistance	Differential Mode		20		kΩ
C _{IN}	Input Capacitance	Common Mode		1.8		- pF
O _{IN}	Input Capacitance	Differential Mode		1		
CMRR	Common Mode Rejection Ration	Input Referred, V _{CM} = 0V to -2.5V	70 68	90		dB
CMVR	Input Common Mode Voltage Range	CMRR ≥ 50 dB		-0.15	0	V
		3.5	3.5	3.7		
Transfer C	Characteristics			Г	1	
A _{VOL}	Large Signal Voltage Gain	$V_{O} = 1.6 V_{PP}, R_{L} = 100\Omega$	58 55	64		dB
Output Ch	aracteristics			-	1	
	Output Swing High	No Load	3.6 3.4	3.75		
V_{O}	Output Swing Low	No Load		0.9	1.1 1.3	V
	Output Swing High	$R_L = 100\Omega$	3.5 3.35	3.70		
	Output Swing Low	$R_L = 100\Omega$		1	1.3 1.45	
I _{sc}	Short Circuit Current (Note 3)	Sourcing , $V_O = 2.5V$ $\Delta V_{IN} = 200 \text{ mV}$	90 80	170		- mA
		Sinking, $V_O = 2.5V$ $\Delta V_{IN} = 200 \text{ mV}$	70 60	140		
	0.1.10	Sourcing, V _O = +3.5V		30		^
I _{OUT}	Output Current	Sinking, V _O = 1.5V		60		mA
R _O	Output Resistance	A _V = +1, f <100 kHz		.08		Ω
Power Sup	oply		·			
PSRR	Power Supply Rejection Ratio	Input Referred , $V_S = \pm 2.5V$ to $\pm 3V$	60	75		dB
I _S	Supply Current (per channel)			4.5	6 7	mA

- Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics Table
- Note 2: Human body model, 1.5 k Ω in series with 100 pF. Machine model: 0Ω in series with 100 pF.
- Note 3: Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature at 150°C.
- Note 4: The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA} and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_J_{MAX)} T_A)/\theta_{JA}$. All numbers apply for packages soldered directly onto a PC board.
- Note 5: Typical Values represent the most likely parametric norm.
- Note 6: All limits are guaranteed by testing or statistical analysis.
- Note 7: Offset voltage average drift is determined by dividing the change in V_{OS} at temperature extremes into the total temperature change.
- Note 8: Slew rate is the slower of the rising and falling slew rates. Slew rate is rate of change from 10% to 90% of output voltage step.

Connection Diagrams





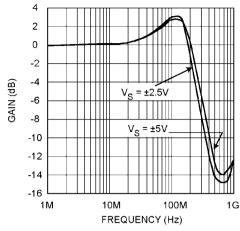


Ordering Information

Package	Part Number	Package Marking	Transport Media	NSC Drawing	
	LMH6654MA	LMH6654MA	95 Units Rails	M08A	
8-Pin SOIC	LMH6654MAX	LIVINOOS4IVIA	2.5k Units Tape and Reel		
6-PIII 50IC	LMH6655MA	LMUGGERMA	95 Units Rails		
	LMH6655MAX	LMH6655MA	2.5k Units Tape and Reel		
5-Pin SOT-23	LMH6654MF	A66A	1k Units Tape and Reel	MEGEA	
5-PIII 501-23	LMH6654MFX	ADDA	3K Units Tape and Reel	MF05A	
o Dia MCOD	LMH6655MM	4074	1k Units Tape and Reel	MULACOA	
8-Pin MSOP	LMH6655MMX	A67A	3.5k Units Tape and Reel	MUA08A	

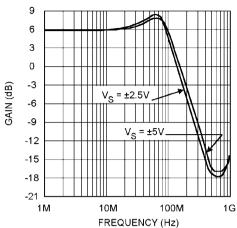
Typical Performance Characteristics $T_J = 25^{\circ}C$, $V^+ = \pm 5V$, $V^- = -5$, $R_F = 25\Omega$ for gain = +1, $R_F = 402\Omega$ and for gain \geq +2, and $R_L = 100\Omega$, unless otherwise specified.





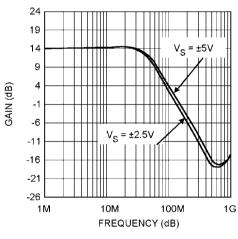
20016509

Closed Loop Bandwidth (G = +2)



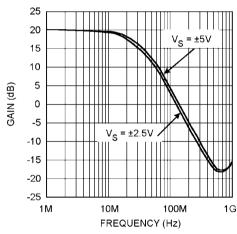
20016510

Closed Loop Bandwidth (G = +5)



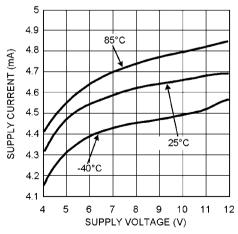
20016511

Closed Loop Bandwidth (G = +10)



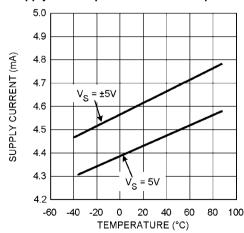
20016512

Supply Current per Channel vs. Supply Voltage



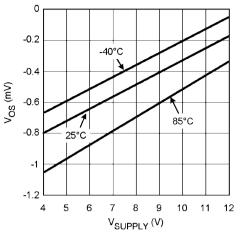
20016535

Supply Current per Channel vs. Temperature

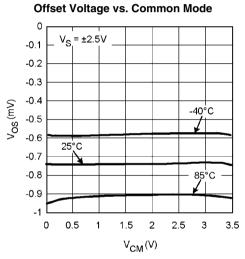


20016548

Offset Voltage vs. Supply Voltage (V_{CM} = 0V)

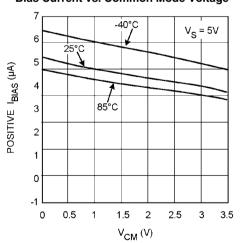


20016549



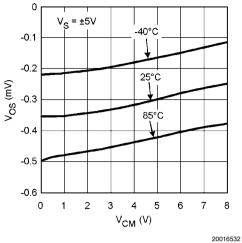
20016539

Bias Current vs. Common Mode Voltage

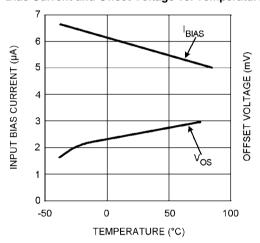


20016537

Offset Voltage vs. Common Mode

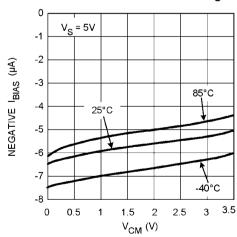


Bias Current and Offset Voltage vs. Temperature

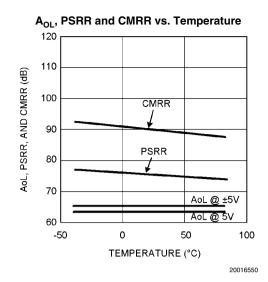


20016551

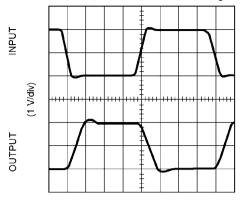
Bias Current vs. Common Mode Voltage



20016565



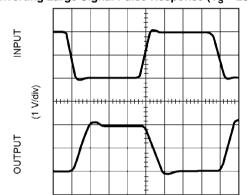
Inverting Large Signal Pulse Response ($V_S = 5V$)



TIME (12.5 ns/div)

20016502

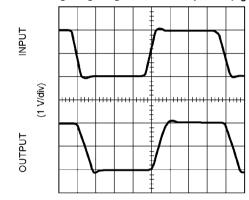
Inverting Large Signal Pulse Response ($V_S = \pm 5V$)



TIME (12.5 ns/div)

20016504

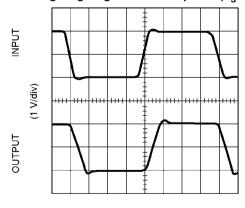
Non-Inverting Large Signal Pulse Response ($V_S = 5V$)



TIME (12.5 ns/div)

20016506

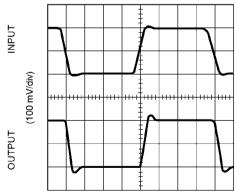
Non-Inverting Large Signal Pulse Response ($V_S = \pm 5V$)



TIME (12.5 ns/div)

20016508

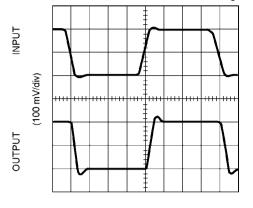
Non-Inverting Small Signal Pulse Response ($V_S = 5V$)



TIME (12.5 ns/div)

20016505

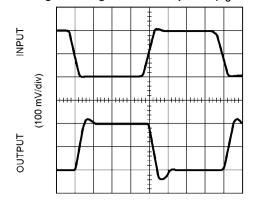
Non-Inverting Small Signal Pulse Response ($V_S = \pm 5V$)



TIME (12.5 ns/div)

20016507

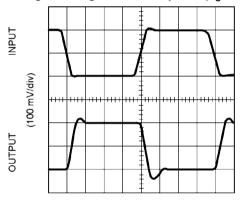
Inverting Small Signal Pulse Response (V_S = 5V)



TIME (12.5 ns/div)

20016501

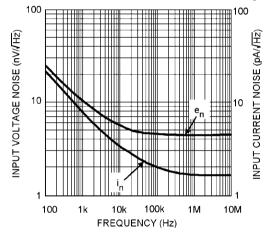
Inverting Small Signal Pulse Response ($V_S = \pm 5V$)



TIME (12.5 ns/div)

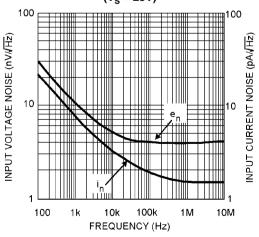
20016503

Input Voltage and Current Noise vs. Frequency (V_S = 5V)



20016513

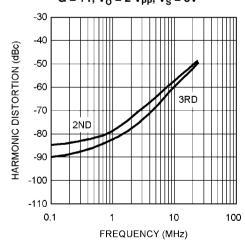
Input Voltage and Current Noise vs. Frequency $(V_S = \pm 5V)$



20016514

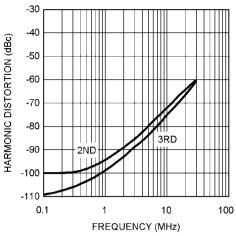
9

Harmonic Distortion vs. Frequency G = +1, $V_O = 2$ V_{PP} , $V_S = 5$ V



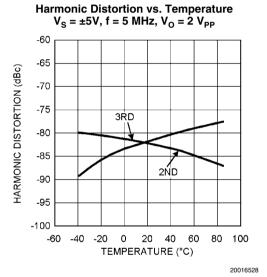
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Harmonic Distortion vs. Frequency G = +1, $V_O = 2$ V_{PP} , $V_S = \pm 5$ V

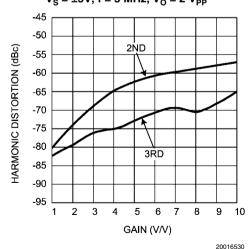


2001651

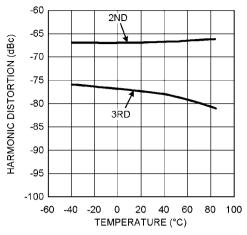
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Harmonic Distortion vs. Gain $V_S = \pm 5V$, f = 5 MHz, $V_O = 2 V_{PP}$

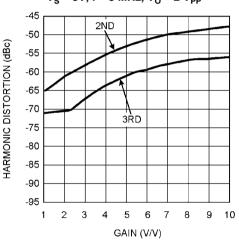


Harmonic Distortion vs. Temperature $V_S = 5V$, f = 5 MHz, $V_O = 2$ V_{PP}



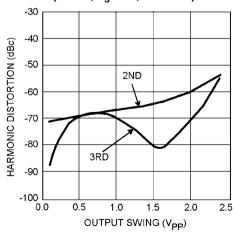
20016529

Harmonic Distortion vs. Gain $V_S = 5V$, f = 5 MHz, $V_O = 2$ V_{PP}



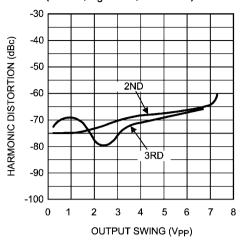
20016531

Harmonic Distortion vs. Output Swing $(G = +2, V_S = 5V, f = 5 MHz)$



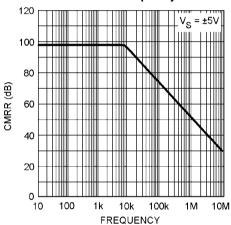
20016559

Harmonic Distortion vs. Output Swing $(G = +2, V_S = \pm 5V, f = 5 \text{ MHz})$



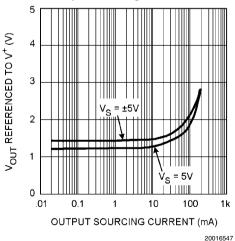
20016522

CMRR vs. Frequency

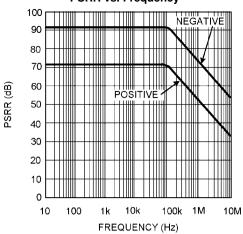


20016564

Output Sourcing Current

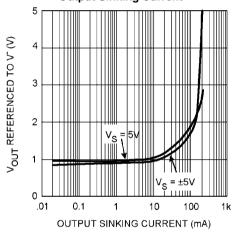


PSRR vs. Frequency



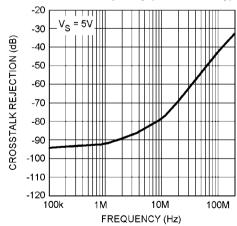
20016516

Output Sinking Current



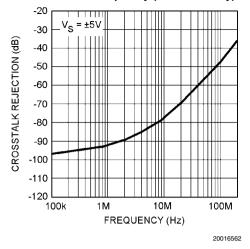
20016546

CrossTalk vs. Frequency (LMH6655 only)

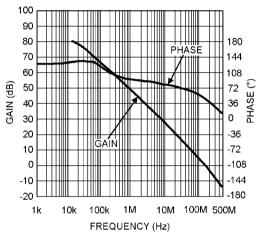


20016561

CrossTalk vs. Frequency (LMH6655 only)



Open Loop Gain and Phase vs. Frequency



Application Information

20016527

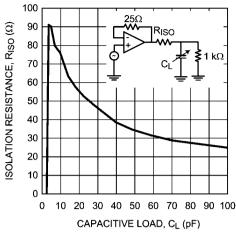
GENERAL INFORMATION

The LMH6654 single and LMH6655 dual high speed, voltage feedback amplifiers are manufactured on National Semiconductor's new VIP10 (Vertically Integrated PNP) complementary bipolar process. These amplifiers can operate from $\pm 2.5 V$ to $\pm 6 V$ power supply. They offer low supply current, wide bandwidth, very low voltage noise and large output swing. Many of the typical performance plots found in the datasheet can be reproduced if 50Ω coax and 50Ω $R_{\text{IN}}/_{\text{ROUT}}$ resistors are used.

CIRCUIT LAYOUT CONSIDERATION

With all high frequency devices, board layouts with stray capacitance have a strong influence on the AC performance. The LMH6654/LMH6655 are not exception and the inverting input and output pins are particularly sensitive to the coupling of parasitic capacitance to AC ground. Parasitic capacitances on the inverting input and output nodes to ground could cause frequency response peaking and possible circuit oscillation. Therefore, the power supply, ground traces and ground plan should be placed away from the inverting input and output pins. Also, it is very important to keep the parasitic capacitance across the feedback to an absolute minimum.

Isolation Resistance vs. Capacitive Load



20016563

The PCB should have a ground plane covering all unused portion of the component side of the board to provide a low impedance path. All trace lengths should be minimized to reduce series inductance.

Supply bypassing is required for the amplifiers performance. The bypass capacitors provide a low impedance return current path at the supply pins. They also provide high frequency filtering on the power supply traces. It is recommended that a ceramic decoupling capacitor 0.1 μF chip should be placed with one end connected to the ground plane and the other side as close as possible to the power pins. An additional 10 μF tantalum electrolytic capacitor should be connected in parallel, to supply current for fast large signal changes at the output.

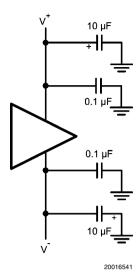


FIGURE 1.

EVALUATION BOARDS

National provides the following evaluation boards as a guide for high frequency layout and as an aid in device testing and characterization.

Device	Package	Evalulation Board PN
LMH6654MF	5-Pin SOT-23	CLC730068
LMH6654MA	8-Pin SOIC	CLC730027
LMH6655MA	8-Pin SOIC	CLC730036
LMH6655MM	8-Pin MSOP	CLC730123

The free evaluation board are shipped automatically when a device sample request is placed with National Semiconductor.

The CLC730027 datasheet also contains tables of recommended components to evaluate several of National's high speed amplifiers. This table for the LMH6654 is illustrated below. Refer to the evaluation board datasheet for schematics and further information.

Components Needed to Evaluate the LMH6654 on the Evaluation Board:

- $R_f R_q$ use the datasheet to select values.
- R_{IN}, R_{OUT} typically 50Ω (Refer to the Basic Operation section of the evaluation board datasheet for details)
- R_f is an optional resistor for inverting again configurations (select R_f to yield desired input impedance = R_n||R_f)
- C₁, C₂ use 0.1 μF ceramic capacitors
- C₃, C₄ use 10 μF tantalum capacitors

Components not used:

- 1. C₅, C₆, C₇, C₈
- 2. R1 thru R8

The evaluation boards are designed to accommodate dual supplies. The board can be modified to provide single operation. For best performance;

- 1) do not connect the unused supply.
- 2) ground the unused supply pin.

POWER DISSIPATION

The package power dissipation should be taken into account when operating at high ambient temperature and/or high power dissipative conditions. In determining maximum operable

temperature of the device, make sure the total power dissipation of the device is considered; this power dissipated in the device with a load connected to the output as well as the nominal dissipation of the op amp.

DRIVING CAPACITIVE LOADS

Capacitive loads decrease the phase margin of all op amps. The output impedance of a feedback amplifier becomes inductive at high frequencies, creating a resonant circuit when the load is capacitive. This can lead to overshoot, ringing and oscillation. To eliminate oscillation or reduce ringing, an isolation resistor can be placed as shown in *Figure 2* below. At frequencies above

$$F = \frac{1}{2 \pi R_{ISO} C_{LOAD}}$$

the load impedance of the Amplifier approaches $R_{\rm ISO}.$ The desired performance depends on the value of the isolation resistor. The isolation resistance vs. capacitance load graph in the typical performance characteristics provides the means for selection of the value of R_S that provides ≤ 3 dB peaking in closed loop $A_V=1$ response. In general, the bigger the isolation resistor, the more damped the pulse response becomes. For initial evaluation, a 50Ω isolation resistor is recommended.

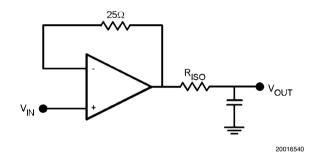


FIGURE 2.

COMPONENTS SELECTION AND FEEDBACK RESISTOR

It is important in high-speed applications to keep all component leads short since wires are inductive at high frequency. For discrete components, choose carbon composition axially leaded resistors and micro type capacitors. Surface mount components are preferred over discrete components for minimum inductive effect. Never use wire wound type resistors in high frequency applications.

Large values of feedback resistors can couple with parasitic capacitance and cause undesired effects such as ringing or oscillation in high-speed amplifiers. Keep resistors as low as possible consistent with output loading consideration. For a gain of 2 and higher, 402Ω feedback resistor used for the typical performance plots gives optimal performance. For unity gain follower, a 25Ω feedback resistor is recommended rather than a direct short. This effectively reduces the Q of what

would otherwise be a parasitic inductance (the feedback wire) into the parasitic capacitance at the inverting input.

BIAS CURRENT CANCELLATION

In order to cancel the bias current errors of the non-inverting configuration, the parallel combination of the gain setting \boldsymbol{R}_g and feedback \boldsymbol{R}_f resistors should equal the equivalent source resistance \boldsymbol{R}_{seq} as defined in Figure 3. Combining this constraint with the non-inverting gain equation, allows both \boldsymbol{R}_f and \boldsymbol{R}_g to be determined explicitly from the following equations:

$$R_f = A_V R_{seq}$$
 and $R_q = R_f/(A_V - 1)$

For inverting configuration, bias current cancellation is accomplished by placing a resistor $R_{\rm b}$ on the non-inverting input equal in value to the resistance seen by the inverting input $(R_{\rm f}/\!/(R_{\rm g}\!+\!R_{\rm s})\!.$ The additional noise contribution of $R_{\rm b}$ can be minimized through the use of a shunt capacitor.

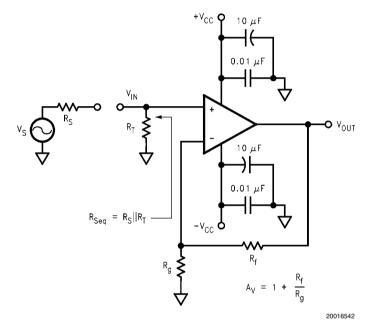


FIGURE 3. Non-Inverting Amplifier Configuration

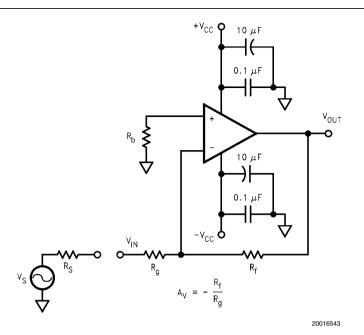


FIGURE 4. Inverting Amplifier Configuration

TOTAL INPUT NOISE VS. SOURCE RESISTANCE

The noise model for the non-inverting amplifier configuration showing all noise sources is described in Figure 5. In addition to the intrinsic input voltage noise (e_n) and current noise $(i_n=i_{n+}=i_{n-})$ sources, there also exits thermal voltage noise $e_t=\sqrt{4kTR}$ associated with each of the external resistors. Equation 1 provides the general form for total equivalent input voltage noise density (e_{ni}) . Equation 2 is a simplification of Equation 1 that assumes

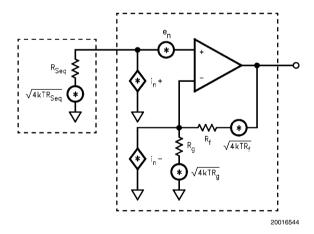


FIGURE 5. Non-Inverting Amplifier Noise Model

$$e_{ni} = \sqrt{e_n^2 + (i_n + R_{seq})^2 + 4kTR_{seq} + (i_n - (R_f || R_g))^2 + 4kT(R_f || R_g)}$$
(1)

Noise Figure

Noise Figure (NF) is a measure of the noise degradation caused by an amplifier.

NF = 10LOG
$$\left[\frac{S_i/N_i}{S_o/N_o}\right]$$
 = 10LOG $\left[\frac{e_{ni}^2}{e_t^2}\right]$ (3)

 $R_f||R_g=R_{seq}$ for bias current cancellation. Figure 6 illustrates the equivalent noise model using this assumption. The total equivalent output voltage noise (e_{no}) is $e_{ni} * A_V$.

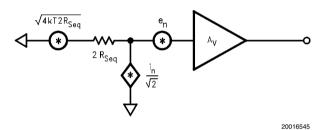


FIGURE 6. Noise Model with $R_f ||R_q = R_{seq}$

$$e_{ni} = \sqrt{e_n^2 + 2 (i_n R_{seq})^2 + 4kT (2R_{seq})}$$
 (2)

If bias current cancellation is not a requirement, then $R_f||R_g|$ does not need to equal $R_{seq}.$ In this case, according to Equation 1, R_fR_g should be as low as possible in order to minimize noise. Results similar to Equation 1 are obtained for the inverting configuration on $Figure\ 2$ if R_{seq} is replaced by R_b and R_g is replaced by $R_g+R_s.$ With these substitutions, Equation 1 will yield an e_{ni} referred to the non-inverting input. Referring to e_{ni} to the inverting input is easily accomplished by multiplying e_{ni} by the ration of non-inverting to inverting gains.

The noise figure formula is shown is Equation 3. The addition of a terminating resistor $R_{\rm T}$, reduces the external thermal noise but increases the resulting NF.

The NF is increased because the $\rm R_T$ reduces the input signal amplitude thus reducing the input SNR.

NF = 10 LOG
$$\left[\frac{e_n^2 + i_n^2 (R_{seq} + (R_f || R_g)^2 + 4KTR_{seq} + 4kt (R_f || R_g)}{4kTR_{seq}} \right]$$
(4)

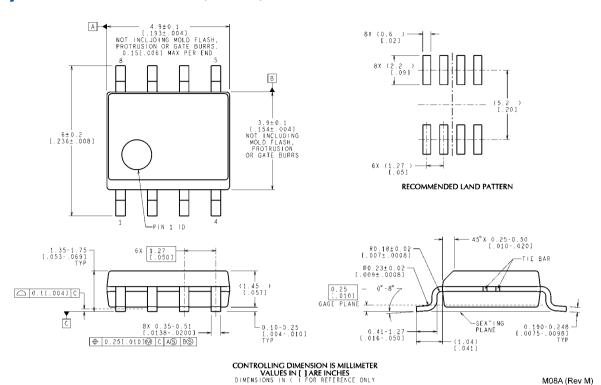
The noise figure is related to the equivalent source resistance (R $_{\rm seq}$) and the parallel combination of R $_{\rm f}$ and R $_{\rm g}$. To minimize noise figure, the following steps are recommended:

 ${\rm R}_{\rm OPT}$ is the point at which the NF curve reaches a minimum and is approximated by:

$$R_{OPT} \approx (e_n/i_n)$$

- 1. Minimize R_fIIR_g
- 2. Choose the Optimum R_s (R_{OPT})

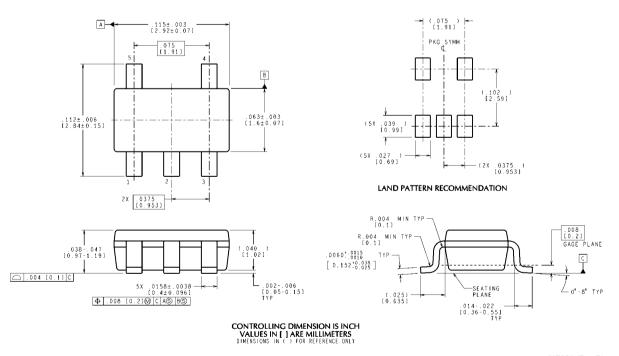
Physical Dimensions inches (millimeters) unless otherwise noted



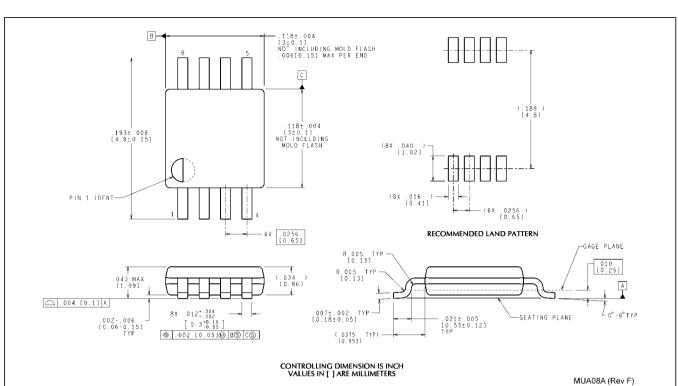
8-Pin SOIC

M08A (Rev M)

NS Package Number M08A



5-Pin SOT-23 **NS Package Number MF05A** MF05A (Rev D)



8-Pin MSOP NS Package Number MUA08A

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LMH6654/LMH6655

Notes

For more National Semiconductor product information and proven design tools, visit the following Web sites at:

Pro	oducts	Design Support		
Amplifiers	www.national.com/amplifiers	WEBENCH® Tools	www.national.com/webench	
Audio	www.national.com/audio	App Notes	www.national.com/appnotes	
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LVDS	www.national.com/lvds	Packaging	www.national.com/packaging	
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green	
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts	
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality	
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback	
Voltage Reference	www.national.com/vref	Design Made Easy	www.national.com/easy	
PowerWise® Solutions	www.national.com/powerwise	Solutions	www.national.com/solutions	
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero	
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